1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	650	V	
Ic	Continuous collector current at T _C = 25 °C	120	Α	
Ic	Continuous collector current at T _C = 100 °C 60		Α	
I _{CP} ⁽¹⁾	Pulsed collector current	240	Α	
V _{GE}	Gate-emitter voltage	± 20	V	
P _{TOT}	Total dissipation at $T_C = 25$ °C	360	W	
t _{SC}	Short-circuit withstand time at $V_{CC} = 400 \text{ V}$, $V_{GE} = 15 \text{ V}$	6	μs	
T _{STG}	Storage temperature range	- 55 to 150	°C	
T_J	Operating junction temperature	- 55 to 150		

^{1.} Pulse width limited by maximum junction temperature and turn-off within RBSOA

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thJC}	Thermal resistance junction-case	0.35	°C/W
R _{thJA}	Thermal resistance junction-ambient	50	°C/W

2 Electrical characteristics

 $T_J = 25$ °C unless otherwise specified.

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 2 mA	650			V
V _{CE(sat)}	Collector-emitter saturation	$V_{GE} = 15 \text{ V}, I_{C} = 60 \text{ A}$		1.9		
	voltage	$V_{GE} = 15 \text{ V}, I_{C} = 60 \text{ A}$ $T_{J} = 125 \text{ °C}$		2.1		V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_C = 1 \text{ mA}$		6.0		V
I _{CES}	Collector cut-off current (V _{GE} = 0)	V _{CE} = 650 V			25	μΑ
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ± 20 V			250	nA

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	V _{CE} = 25 V, f = 1 MHz, V _{GE} =0	-	7150 275 140	-	pF pF pF
Qg	Total gate charge			217		nC
Q _{ge}	Gate-emitter charge	$V_{CC} = 400 \text{ V, } I_{C} = 60 \text{ A,}$ $V_{GE} = 15 \text{ V}$		67		nC
Q _{gc}	Gate-collector charge	GL -		97		nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} (1) t _r (1) (di/dt) _{on} (1)	Turn-on delay time Current rise time Turn-on current slope	$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V}$	-	65 30 2000	-	ns ns A/µs
$t_{d(on)}^{(1)}$ $t_r^{(1)}$ $(di/dt)_{on}^{(1)}$	Turn-on delay time Current rise time Turn-on current slope	$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V}$ $T_{J} = 125 \text{ °C}$	-	63 33 1800	-	ns ns A/µs
$\begin{array}{c} t_{r}(V_{off}) \\ t_{d}(_{off}) \\ t_{f} \end{array}$	Off voltage rise time Turn-off delay time Current fall time	$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V}$	1	35 180 43	-	ns ns ns
$t_{r}(V_{off})$ $t_{d}(_{off})$ t_{f}	Off voltage rise time Turn-off delay time Current fall time	$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V}$ $T_{J} = 125 \text{ °C}$	-	46 210 85	-	ns ns ns

Eon is the turn-on losses when a SiC diode (STPSC1206D) is used in the test circuit in Figure 17. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs and diode are at the same temperature (25 °C and 125 °C).

Table 7. Switching energy (inductive load)

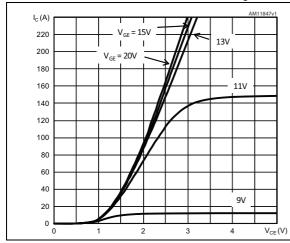
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon (1)	Turn-on switching losses	$V_{CF} = 400 \text{ V}, I_{C} = 60 \text{ A},$		0.75		mJ
E _{off} ⁽²⁾	Turn-off switching losses	$R_G = 10 \Omega$, $V_{GF} = 15 V$	-	1.05	-	mJ
E _{ts}	Total switching losses			1.80		mJ
Eon (1)	Turn-on switching losses	$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$		0.8		mJ
E _{off} (2)	Turn-off switching losses	$R_G = 10 \Omega$, $V_{GE} = 15 V$	-	1.4	-	mJ
E _{ts}	Total switching losses	T _J = 125 °C		2.2		mJ

Eon is the turn-on losses when a SiC diode (STPSC1206D) is used in the test circuit in *Figure 17*. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs and diode are at the same temperature (25 °C and 125 °C).

^{2.} Turn-off losses include also the tail of the collector current.

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics ($T_J = -40$ °C) Figure 3. Output characteristics ($T_J = 25$ °C)



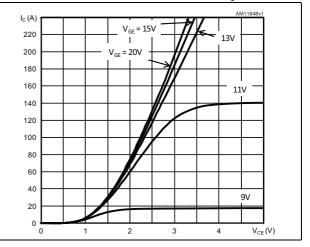
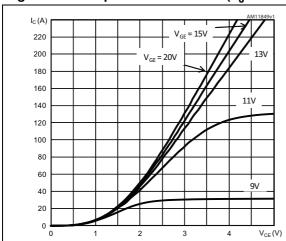


Figure 4. Output characteristics ($T_J = 150$ °C) Figure 5. Transfer characteristics



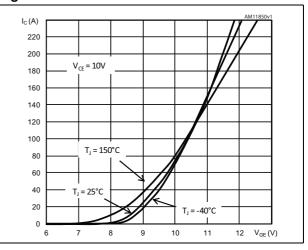


Figure 6. V_{CE(SAT)} vs. junction temperature Fig

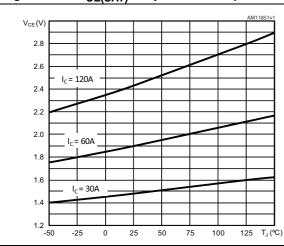
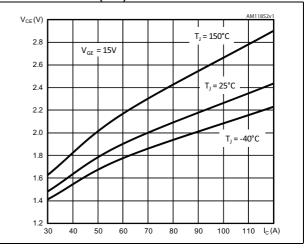


Figure 7. $V_{CE(SAT)}$ vs. collector current



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Figure 8. Normalized $V_{GE(th)}$ vs. junction temperature

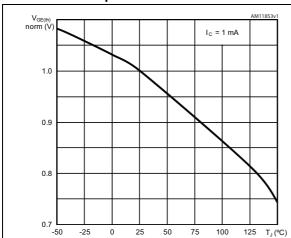


Figure 9. Gate charge vs. gate-emitter voltage

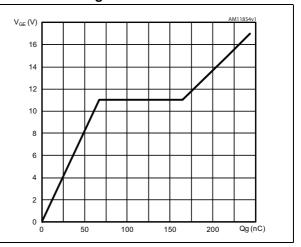


Figure 10. Capacitance variations (f = 1 MHz, $V_{GE} = 0$)

Figure 11. Switching losses vs. collector current

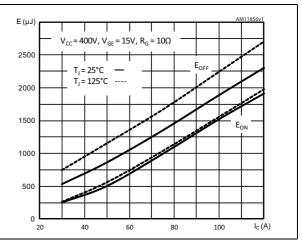
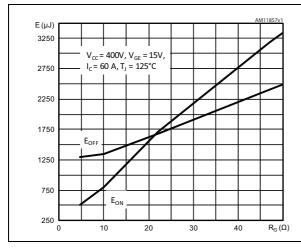
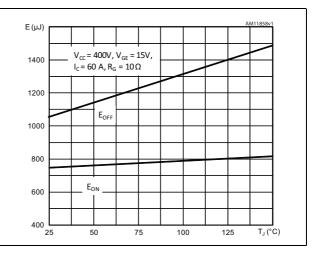


Figure 12. Switching losses vs. gate resistance

Figure 13. Switching losses vs. temperature





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Figure 14. Turn-OFF SOA

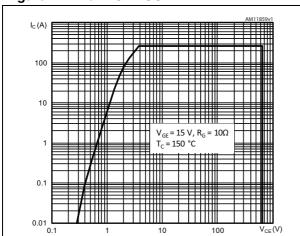


Figure 15. Short circuit time & current vs. V_{GE}

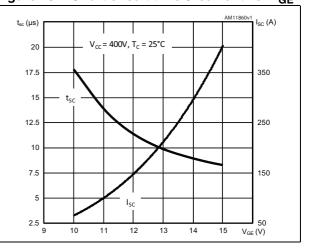
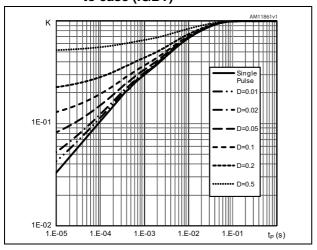


Figure 16. Maximum normalized Z_{th} junction to case (IGBT)



3 Test circuits

Figure 17. Test circuit for inductive load switching

Figure 18. Gate charge test circuit

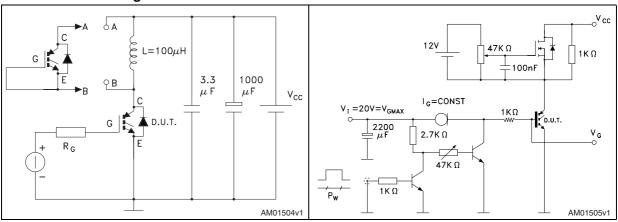
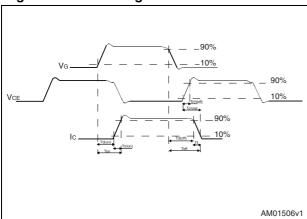


Figure 19. Switching waveform



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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

Table 8. TO-247 mechanical data

Dim.		mm	
Dilli.	Min.	Тур.	Max.
А	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е		5.45	
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S		5.50	

Figure 20. TO-247 drawing

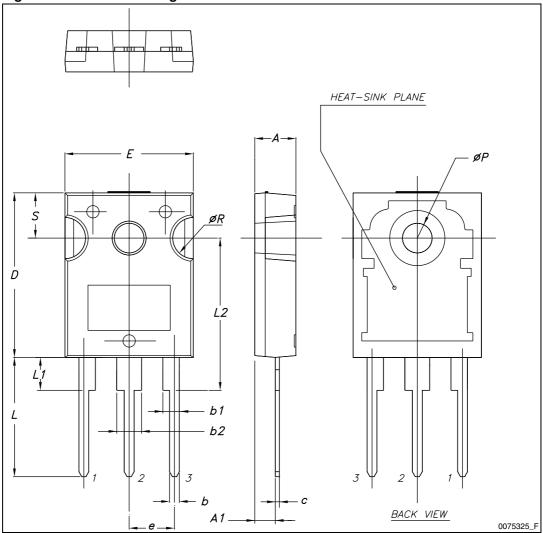
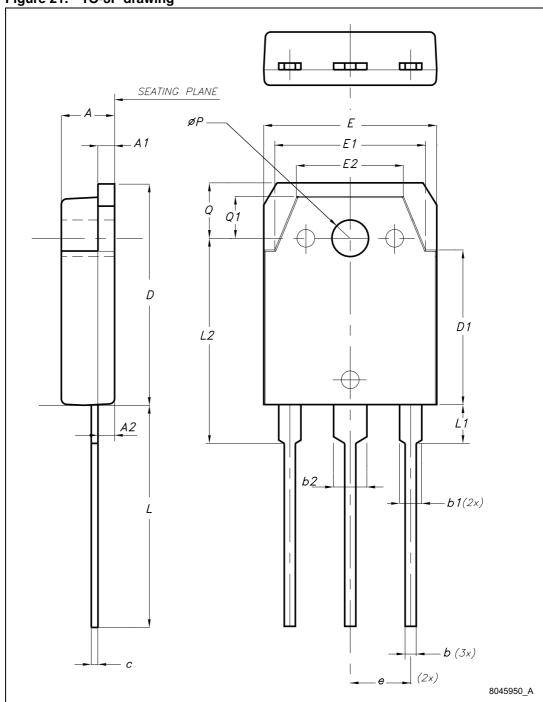


Table 9. TO-3P mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
Α	4.60		5
A1	1.45	1.50	1.65
A2	1.20	1.40	1.60
b	0.80	1	1.20
b1	1.80		2.20
b2	2.80		3.20
С	0.55	0.60	0.75
D	19.70	19.90	20.10
D1		13.90	
Е	15.40		15.80
E1		13.60	
E2		9.60	
е	5.15	5.45	5.75
L	19.50	20	20.50
L1		3.50	
L2	18.20	18.40	18.60
øΡ	3.10		3.30
Q		5	
Q1		3.80	

Figure 21. TO-3P drawing



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5 Revision history

Table 10. Document revision history

Date	Revision	Changes
05-Jul-2011	1	Initial release.
12-Jan-2012	2	Document status promoted from preliminary data to datasheet.
10-Feb-2012	3	Added: Section 2.1: Electrical characteristics (curves).
31-Jul-2012	4	Updated: Figure 8 on page 6.
09-Jan-2013 5		Added: new order code STGWT60H65F, package mechanical data Table 9 on page 11 and Figure 21 on page 12.

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